Onsemi

NVH4L070N120M3S

Features

- Typ. $R_{DS(on)} = 65 \text{ m}\Omega @ V_{GS} = 18 \text{ V}$
- Ultra Low Gate Charge (Q_{G(tot)} = 57 nC)
- High Speed Switching with Low Capacitance ($C_{oss} = 57 \text{ pF}$)
- 100% Avalanche Tested
- AEC-Q101 Qualified and PPAP Capable
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb-Free 2LI (on second level interconnection)

Typical Applications

- Automotive On Board Charger
- Automotive DC-DC Converter for EV/HEV

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

()						
Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	1200	V	
Gate-to-Source Voltage			V _{GS}	-10/+22	V	
Recommended Operation Values of Gate-to-Source Voltage		T _C <175°C	V _{GSop}	-3/+18	V	
Continuous Drain Current (Notes 1, 3)	Steady T _C =25°C		Ι _D	34	A	
Power Dissipation (Note 1)			PD	160	W	
Continuous Drain Current (Notes 1, 3)	Steady State	T _C =100°C	Ι _D	24	A	
Power Dissipation (Note 1)			PD	80	W	
Pulsed Drain Current (Note 2)	$T_{C} = 25^{\circ}C$		I _{DM}	98	A	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode) $T_C = 25^{\circ}C$, $V_{GS} = -3 V$			۱ _S	31	A	
Single Pulse Drain-to-Source Avalanche Energy (Note 4)			E _{AS}	91	mJ	
Maximum Lead Temperature for Soldering (1/25" from case for 10 s)			ΤL	270	°C	

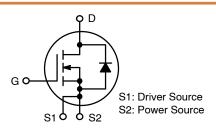
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted. 2. Repetitive rating, limited by max junction temperature.

3. The maximum current rating is based on typical $R_{DS(on)}$ performance. 4. EAS of 91 mJ is based on starting $T_J = 25^{\circ}$ C; L = 1 mH, $I_{AS} = 13.5$ A,

 $V_{DD} = 100 \text{ V}, V_{GS} = 18 \text{ V}.$

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
1200 V	87 mΩ @ 18 V	34 A	



N-CHANNEL MOSFET



H4L070 120M3S AYWWZZ

MARKING DIAGRAM

H4L070120M3S = Specific Device Code

А = Assembly Location Υ

= Year

WW = Work Week

ΖZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping
NVH4L070N120M3S	TO-247-4L	30 Units / Tube

Table 1. THERMAL CHARACTERISTICS

Parameter	Symbol	Max	Unit
Junction-to-Case - Steady State (Note 1)	$R_{\theta JC}$	0.94	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	40	

Table 2. ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

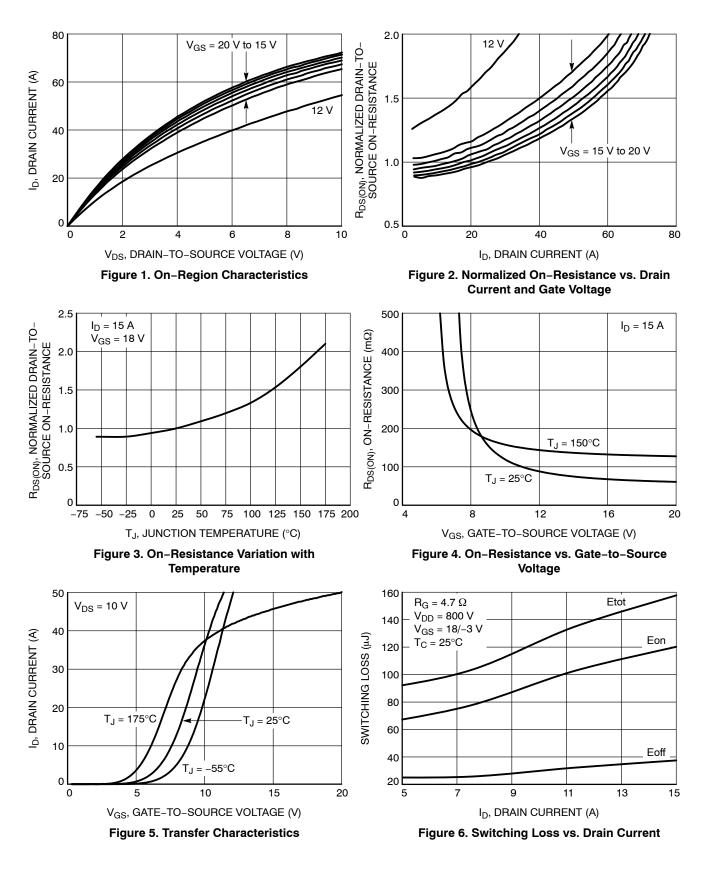
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF-STATE CHARACTERISTICS		-				
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 1 mA	1200	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	I _D = 1 mA, referenced to 25°C (Note 6)	-	0.3	-	V/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V, \\ V_{DS} = 1200 V $ $T_{J} = 25^{\circ}C$	-	-	100	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS} = +22/-10 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	±1	μΑ
ON-STATE CHARACTERISTICS (Note 2)						
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 7 \text{ mA}$	2.04	2.9	4.4	V
Recommended Gate Voltage	V _{GOP}		-3	-	+18	V
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 18 V, I _D = 15 A, T _J = 25°C	-	65	87	mΩ
		V _{GS} = 18 V, I _D = 15 A, T _J = 175°C (Note 6)	-	136	-	
Forward Transconductance	9 _{FS}	V _{DS} = 10 V, I _D = 15 A (Note 6)	-	12	-	S
CHARGES, CAPACITANCES & GATE RE	SISTANCE	•				
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 800 V	-	1230	-	pF
Output Capacitance	C _{OSS}		-	57	-	1
Reverse Transfer Capacitance	C _{RSS}		-	5	-	1
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -3/18 \text{ V}, V_{DS} = 800 \text{ V},$ $I_D = 15 \text{ A}$	-	57	-	nC
Threshold Gate Charge	Q _{G(TH)}	I _D = 15 A	-	3.2	-	1
Gate-to-Source Charge	Q _{GS}		-	9.6	-	1
Gate-to-Drain Charge	Q _{GD}		-	17	-	1
Gate-Resistance	R _G	f = 1 MHz	-	4.3	-	Ω
SWITCHING CHARACTERISTICS		•				
Turn-On Delay Time	t _{d(ON)}	$V_{GS} = -3/18 \text{ V}, V_{DS} = 800 \text{ V},$	-	9.2	-	ns
Rise Time	t _r	$I_D = 15 \text{ A}, R_G = 4.7 \Omega$ Inductive load (Notes 5, 6)	-	11	-	1
Turn–Off Delay Time	t _{d(OFF)}		-	29	-	1
Fall Time	t _f		-	8.8	-	1
Turn–On Switching Loss	E _{ON}		-	124	-	μJ
Turn–Off Switching Loss	E _{OFF}		-	36	-	1
Total Switching Loss	E _{tot}		-	160	-	1
SOURCE-DRAIN DIODE CHARACTERIS	TICS					
Continuous Source-Drain Diode Forward Current	I _{SD}	V_{GS} = -3 V, T_C = 25°C (Note 6)	_	-	31	A
Pulsed Source-Drain Diode Forward Current (Note 2)	I _{SDM}		-	-	98	
Forward Diode Voltage	V _{SD}	V _{GS} = –3 V, I _{SD} = 15 A, T _J = 25°C	-	4.7	-	V

Table 2. ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified) (continued)

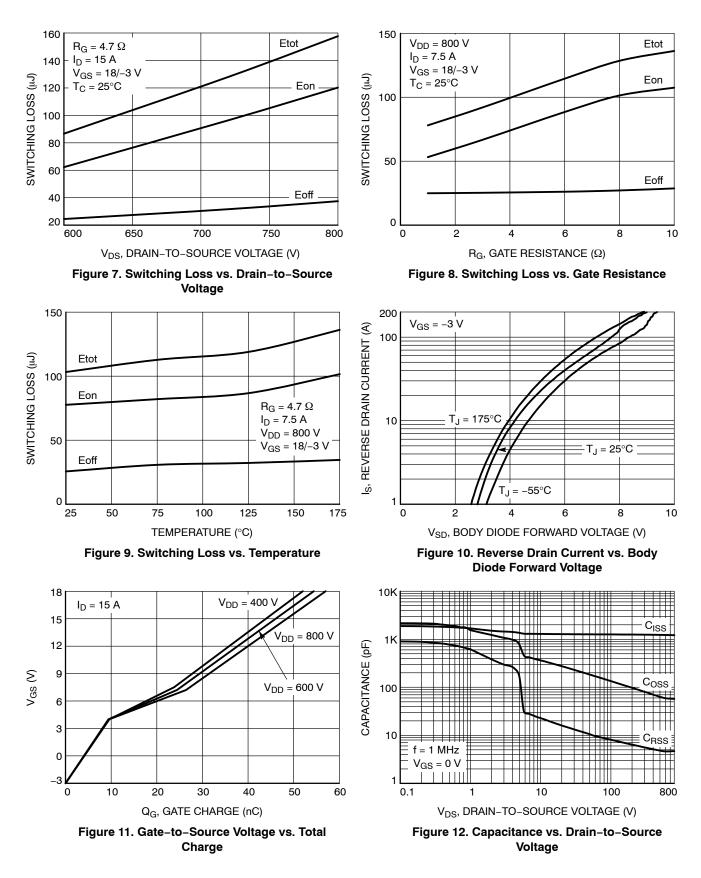
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
SOURCE-DRAIN DIODE CHARACTERISTICS								
Reverse Recovery Time	t _{RR}	$V_{GS} = -3/18 \text{ V}, \text{ I}_{SD} = 15 \text{ A},$ $d\text{I}_S/dt = 1000 \text{ A}/\mu\text{s}, \text{ V}_{DS} = 800 \text{ V}$	-	14.4	-	ns		
Reverse Recovery Charge	Q _{RR}	dl _S /dt = 1000 Α/μs, V _{DS} = 800 V (Note 6)	-	60	-	nC		
Reverse Recovery Energy	E _{REC}		-	4.8	-	μJ		
Peak Reverse Recovery Current	I _{RRM}		-	8.4	-	А		
Charge Time	T _A		-	7.9	-	ns		
Discharge Time	Τ _Β		-	6.5	-	ns		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
5. E_{ON}/E_{OFF} result is with body diode.
6. Defined by design, not subject to production test.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

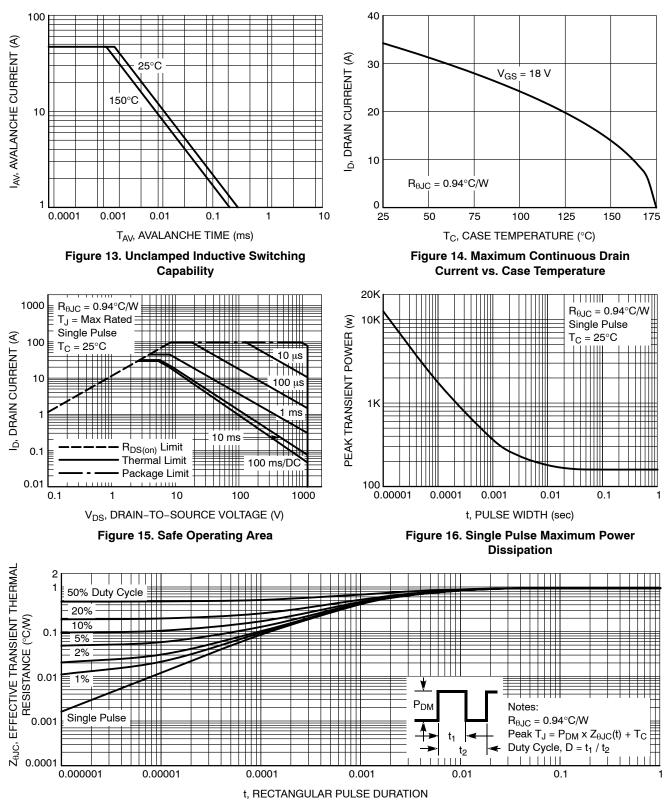


Figure 17. Junction-to-Case Transient Thermal Response



TO-247-4LD CASE 340CJ **ISSUE A**

DATE 16 SEP 2019

NOM

5.00

2.40

2.00

1.20

1.40

2.22

0.60

22.54

16.25

1.17

2.54 BSC

5.08 BSC

15.60

13.00

5.00

18.42

2.62

3.60

6.80

6.17

6.17

3.40

6.60

5.97

5.97

р p1

Q

S

MAX

5.20

2.70

2.20

1.33

1.60

2.42

0.70

22.74

16.50

1.37

15.80

13.20

5.20

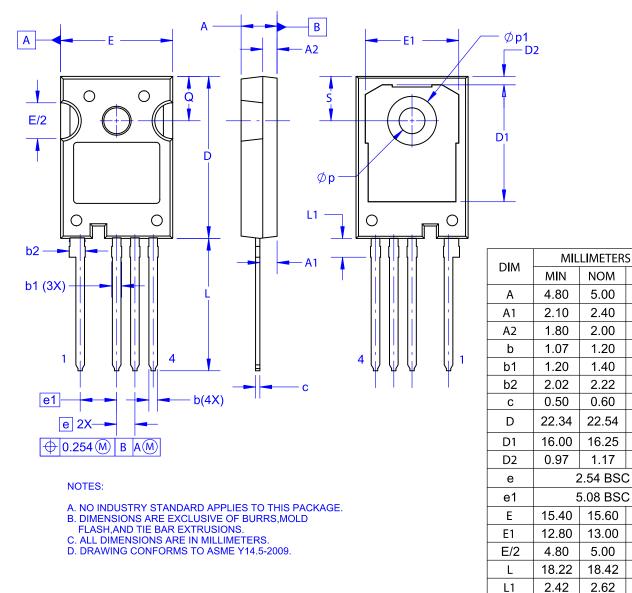
18.62

2.82

3.80

7.00 6.37

6.37



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